

# 四通道、低电容ESD保护二级管阵列

# UM5204EECD *SOT23-6* UM5204EECE *SOT23-6*

#### 描述

UM5204EECD/EECE系列浪涌额定二极管阵列专为保护高速数据传输接口而设计。该系列专为保护连接到数据线和传输线上的敏感元件而设计,使其免受静电放电(ESD)、快速瞬态电流(EFT)和雷击引发的过压损害。

该器件采用独特设计,将浪涌额定、低电容的转向二极管和一个TVS二极管集成在一个封装中。在瞬态条件下,转向二极管会将瞬态电压导向电源线的正极或接地端。内部TVS二极管可防止电源线上出现过压,从而保护所有下游元件。

UM5204EECD/EECE具有1pF的低典型电容,工作频率高达 2GHz且几乎没有插入损耗。因此,该器件非常适合保护 USB2.0、Firewire、DVI 和千兆以太网接口等高速数据线。

UM5204EECD/EECE的低电容阵列配置允许用户保护四条高速数据或传输线路。低电感结构最大程度地减少了大浪涌电流时的过冲电压。该器件针对便携式电子设备的ESD保护进行了优化,可满足IEC 61000-4-2标准的第4级静电抗扰度要求: ±15kV 空气间隙放电和 ±8kV 接触放电。

#### 应用

- USB 2.0
- USB OTG
- 10/100/1000Mbit 以太网
- 显示器和平板
- 显示器数字视频接口(DVI)
- 高清多媒体接口(HDMI)
- SIM 端口
- IEEE 1394 火线端口

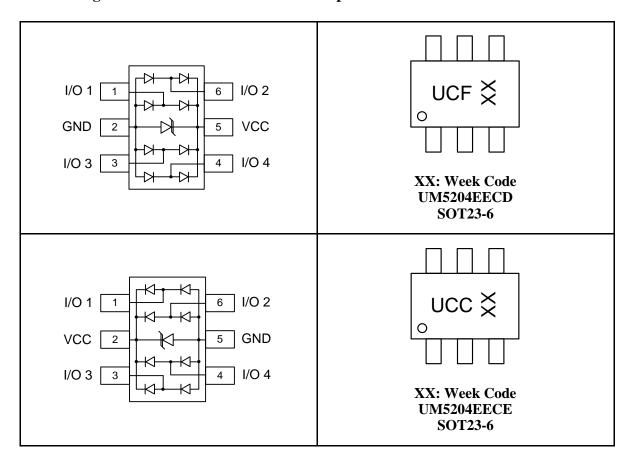
#### 特性

- 高速数据线瞬态保护,符合IEC 61000-4-2标准: ±20kV(空气间隙放电),±12kV(接触放电)符合IEC 61000-4-4 (EFT)标准: 40A (5/50ns)符合IEC 61000-4-5(Lighting)标准: 10A (8/20μs)
- 带内部TVS二极管的浪涌额定二极管阵列
- 最多可保护四条I/O线和电源线
- 适用于高速接口的低电容特性(<1pF),频率 高达2.0GHz无插入损耗
- 低漏电流和钳位电压
- 低工作电压: 5.0V



# **Pin Configurations**

# **Top View**



# **Ordering Information**

Part Number	Working Voltage	Packaging Type	Channel	Marking Code	Shipping Qty
UM5204EECD	5.0V	SOT23-6	4	UCF	3000pcs/7 Inch Tape & Reel
UM5204EECE	5.0V	SOT23-6	4	UCC	3000pcs/7 Inch Tape & Reel

# **Absolute Maximum Ratings**

Rating	Symbol	Value	Unit
Peak Pulse Power (t <sub>P</sub> =8/20 μs)	$P_{pk}$	200	Watts
Peak Pulse Current (t <sub>P</sub> =8/20 μs)	$I_{PP}$	10	A
Peak Pulse Current (t <sub>P</sub> =5/50ns)	$I_{PP}$	40	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	$V_{\mathrm{ESD}}$	±20 ±12	kV
Operating Temperature	$T_{J}$	-55 to +125	${\mathcal C}$
Storage Temperature	$T_{STG}$	-55 to +150	${\mathcal C}$



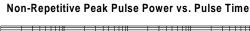
# **Electrical Characteristics (Note 1)**

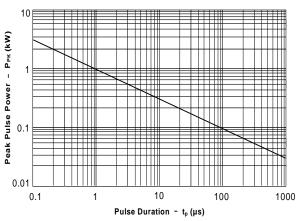
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Reverse Stand-Off Voltage	$V_{RWM}$	VCC to GND			5.0	V
Reverse Breakdown Voltage	$V_{BR}$	$I_{T}=1  \text{mA},$ VCC to GND	6.0			V
Reverse Leakage Current	$I_R$	V <sub>RWM</sub> =5V, VCC to GND			2	μА
Clamping Voltage	$V_{\rm C}$	I <sub>PP</sub> =1A, 8/20 μs Any I/O Pin to GND		8	10	V
Clamping Voltage	$V_{\rm C}$	I <sub>PP</sub> =5A, 8/20 μs Any I/O Pin to GND		12	15	V
	C <sub>j</sub>	V <sub>R</sub> =0V, f=1MHz Any I/O Pin to GND			2	pF
Junction		V <sub>R</sub> =0V, f=1MHz, Between I/O Pins			1	pF
Capacitance		$V_R$ =0V, f=1MHz VCC to GND		60		pF
		V <sub>R</sub> =2.5V, f=1MHz VCC to GND		40		pF
		Any I/O Pin to VCC		130		ns
Reverse Recovery Time	Trr	GND to VCC		300		ns
Time		GND to any I/O Pin		400		ns

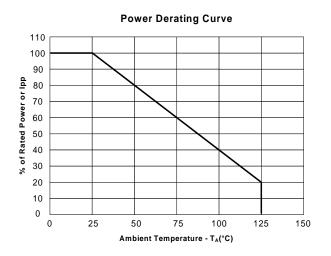
Note 1: I/O pins are pin 1, 3, 4, and 6



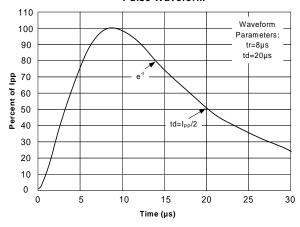
# **Typical Operating Characteristics**



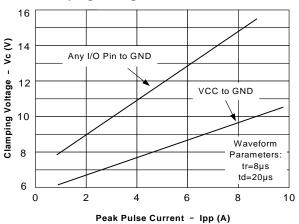




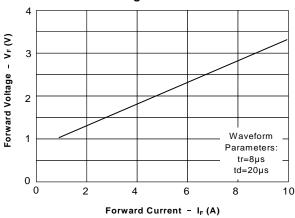
#### **Pulse Waveform**



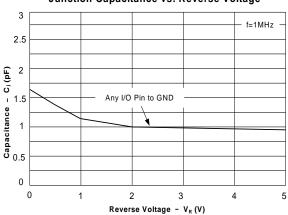
#### Clamping Voltage vs. Peak Pulse Current



#### Forward Voltage vs. Forward Current



#### Junction Capacitance vs. Reverse Voltage



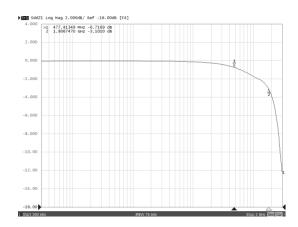


# **Typical Operating Characteristics (Continued)**

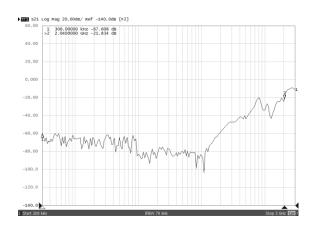
## **Single End Bandwidth**

# 

## **Differential Bandwidth**



## Crosstalk



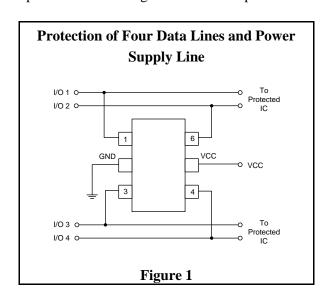


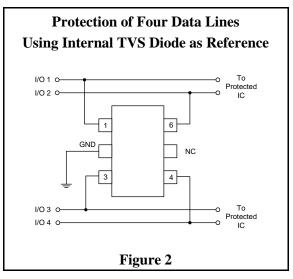
#### **Applications Information**

#### **Device Connection Options for Protection of Four High-Speed Data Lines**

This device is designed to protect four data lines by clamping them to a fixed reference. When the voltage on the protected line exceeds the reference voltage the steering diodes are forward biased, conducting the transient current away from the sensitive circuitry. Data lines are connected at I/O pins. GND pin should be connected directly to a ground plane. The path length is kept as short as possible to minimize parasitic inductance. The positive reference is connected at VCC pin. The options for connecting the positive reference are as follows:

- 1. To protect data lines and the power line, connect VCC pin directly to the positive supply rail (VCC). In this configuration the data lines are referenced to the supply voltage. The internal TVS diode prevents over-voltage on the supply rail. See Figure 1.
- 2. In applications where the supply rail does not exit the system, the internal TVS may be used as the reference. In this case, VCC pin is not connected. The steering diodes will begin to conduct when the voltage on the protected line exceeds the working voltage of the TVS (plus one diode drop).
- 3. In applications where complete supply isolation is desired, the internal TVS is again used as the reference and VCC is connected to one of the I/O inputs. An example of this configuration is the protection of a SIM port. The Clock, Reset, I/O, and VCC lines are connected at I/O pins. GND pin is connected to ground and VCC pin is not connected. See Figure 2.

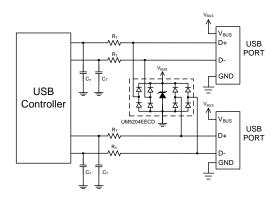




#### **Universal Serial Bus ESD Protection**

The UM5204EECD/EECE may also be used to protect the USB ports on monitors, computers, peripherals or portable systems. Each device will protect up to two USB ports (Figure 3). When the voltage on the data lines exceed the bus voltage (plus one diode drop), the internal rectifiers are forward biased conducting the transient current away from the protected controller chip. The TVS diode directs the surge to ground. The TVS diode also acts to suppress ESD strikes directly on the voltage bus. Thus, both power and data pins are protected with a single device.





**Figure 3 Dual USB Port Protection** 

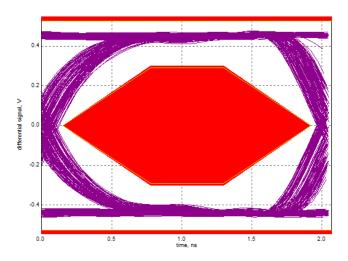


Figure 4 USB Eye Diagram

Note: Figure 4 is tested by the MSO9254A oscilloscope of Agilent including E2678 probe, 1169 differential probe and E2645B-66401 fixture, when the chip is linked into the data line.

#### 10/100 Ethernet Protection

Ethernet ICs are vulnerable to damage from electrostatic discharge (ESD). The internal protection in the PHY chip, if any, often is not enough due to the high energy of the discharges specified by IEC61000-4-2. If the discharge is catastrophic, it will destroy the protected IC. If it is less severe, it will cause latent failures that are very difficult to find.

10/100 Ethernet operates at 125MHz clock over a twisted pair interface. In a typical system, the twisted pair interface for each port consists of two differential signal pairs: one for the transmitter and one for the receiver, with the transmitter input being the most sensitive to damage. The fatal discharge occurs differentially across the transmitter or receiver line pair and is capacitively coupled through the transformer to the Ethernet chip. Figure 5 shows how to design the UM5204EECD/EECE on the line side of a 10/100 ethernet port to provide differential mode protection. The common mode isolation of the transformer will provide common mode protection to the rating of the transformer isolation which is usually >1.5kV. If more common mode protection is needed, figure 6 shows how to design the UM5204EECD/EECE on the IC side of the 10/100 Ethernet circuit to provide differential and common mode protection. The UM5204EECD/EECE can not be grounded on the line side because the hi-pot test requires the line side not to be grounded.



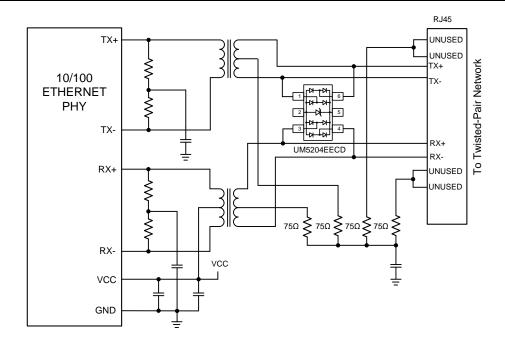


Figure 5 10/100 Ethernet Differential Protection

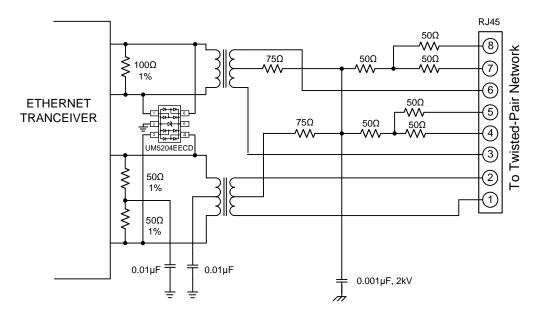


Figure 6 10/100 Ethernet Differential and Common Mode Protection

#### **Matte Tin Lead Finish**

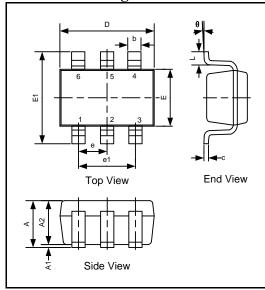
Matte tin has become the industry standard lead-free replacement for SnPb lead finishes. A matte tin finish is composed of 100% tin solder with large grains. Since the solder volume on the leads is small compared to the solder paste volume that is placed on the land pattern of the PCB, the reflow profile will be determined by the requirements of the solder paste. Therefore, these devices are compatible with both lead-free and SnPb assembly techniques. In addition, unlike other lead-free compositions, matte tin does not have any added alloys that can cause degradation of the solder joint.



# **Package Information**

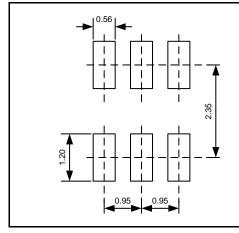
## **UM5204EECD SOT23-6**

# **Outline Drawing**



DIMENSIONS							
Symbol	MILLIMETERS			INCHES			
	Min	Тур	Max	Min	Тур	Max	
A	1.013	1.15	1.40	0.040	0.045	0.055	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A2	1.00	1.10	1.30	0.039	0.043	0.051	
b	0.30	-	0.50	0.012	-	0.020	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.82	-	3.10	0.111	-	0.122	
Е	1.50	1.60	1.70	0.059	0.063	0.067	
E1	2.60	2.80	3.00	0.102	0.110	0.118	
e	0.95REF			0.037REF			
e1	1.90REF			0.075REF			
L	0.30	-	0.60	0.012	-	0.024	
θ	0 °	-	8°	0°	-	8°	

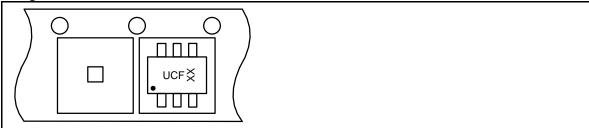
## **Land Pattern**



#### NOTES:

- 1. Compound dimension: 2.92×1.60;
- 2. Unit: mm;
- 3. General tolerance ±0.05mm unless otherwise specified;
- 4. The layout is just for reference.

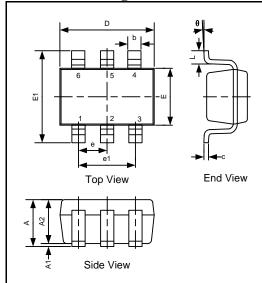
## **Tape and Reel Orientation**





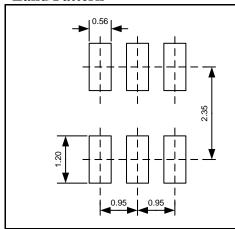
## **UM5204EECE SOT23-6**

# **Outline Drawing**



DIMENSIONS							
Symbol	MILLIMETERS			INCHES			
	Min	Тур	Max	Min	Тур	Max	
A	1.013	1.15	1.40	0.040	0.045	0.055	
A1	0.00	0.05	0.10	0.000	0.002	0.004	
A2	1.00	1.10	1.30	0.039	0.043	0.051	
b	0.30	-	0.50	0.012	-	0.020	
С	0.10	0.15	0.20	0.004	0.006	0.008	
D	2.82	-	3.10	0.111	-	0.122	
Е	1.50	1.60	1.70	0.059	0.063	0.067	
E1	2.60	2.80	3.00	0.102	0.110	0.118	
e	0.95REF			0.037REF			
e1	1.90REF			0.075REF			
L	0.30	-	0.60	0.012	-	0.024	
θ	0 °	-	8°	0 °	-	8°	

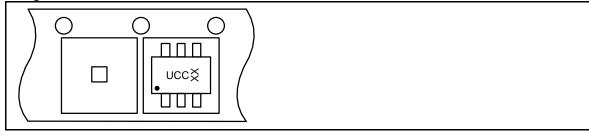
## **Land Pattern**



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## **Tape and Reel Orientation**





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